



Dynatron K785 Active Heatsink for 2U Servers - Socket LGA1156

Special Price
\$16.88 was
\$22.50

Product Images



Short Description

Dynatron Active Heat Sink for 2U Server. Recommend for Intel® Core™ i5 I5-750; Xeon® Processor 3400 Series; Core™ i7 Processors I7-870 & I7-860; Socket LGA1156

Description

Product Details:

Dynatron Active Heat Sink for 2U Server. Recommend for Intel® Core™ i5 I5-750; Xeon® Processor 3400 Series; Core™ i7 Processors I7-870 & I7-860; Socket LGA1156

Features

Features:



Specifications

Specifications:

CPU Socket 1156



CPU Support Intel® Core™ i5 I5-750; Xeon® Processor 3400 Series; Core™ i7 Processors, I7-870 & I7-860



Solution 2U&Up Server



Overall Dimension 90.0 x 90.0 x 62.0 mm



Weight 500 g



Material Aluminum Extruded Radial Fin Heatsink with Copper Inserted



Fan Dimension 77 x 77 x 20 mm



Speed At Duty Cycle 0~20%: 1000 RPM
At Duty Cycle 50%: 2500 RPM
At Duty Cycle 100%: 4500 RPM



Bearing 2 Ball Bearing



Rated Voltage 12 V



Power At Duty Cycle 0~20%: 0.84 W
At Duty Cycle 50%: 1.44 W
At Duty Cycle 100%: 6.0 W



Air Flow At Duty Cycle 0~20%: 10.12 CFM
At Duty Cycle 50%: 25.30 CFM
At Duty Cycle 100%: 45.56 CFM



Noise Level At Duty Cycle 0~20%: 13.14 dBA
At Duty Cycle 50%: 33.04 dBA
At Duty Cycle 100%: 45.8 dBA



Air Pressure At Duty Cycle 0~20%: 0.185mm-H2O
At Duty Cycle 50%: 1.156mm-H2O
At Duty Cycle 100%: 3.746mm-H2O



Lead Wire Pin Out Pin1-Black (-)
Pin2-Yellow (+)
Pin3-Green (Tachometer/Signal output)
Pin4-Blue (PWM)



Thermal
Resistance
& Noise
Level VS.
Cooling Fan
Speed



Note

1. Thermal Grease Pre-Printed with GE-Toshiba TIG830SP
2. RoHS Compliance

Additional Information

Brand	Dynatron
SKU	K785-D
Weight	1.0000
Compatibilty	Intel LGA 1156
Material	Copper/Aluminum
Special Price	\$16.88

